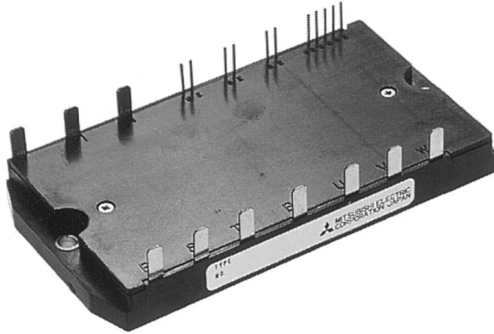


CM50MD-12H

MEDIUM POWER SWITCHING USE INSULATED TYPE

CM50MD-12H



- Ic 50A
- VCES 600V
- Insulated Type
- CIB Module
3 ϕ Inverter+3 ϕ Converter+Brake
- UL Recognized

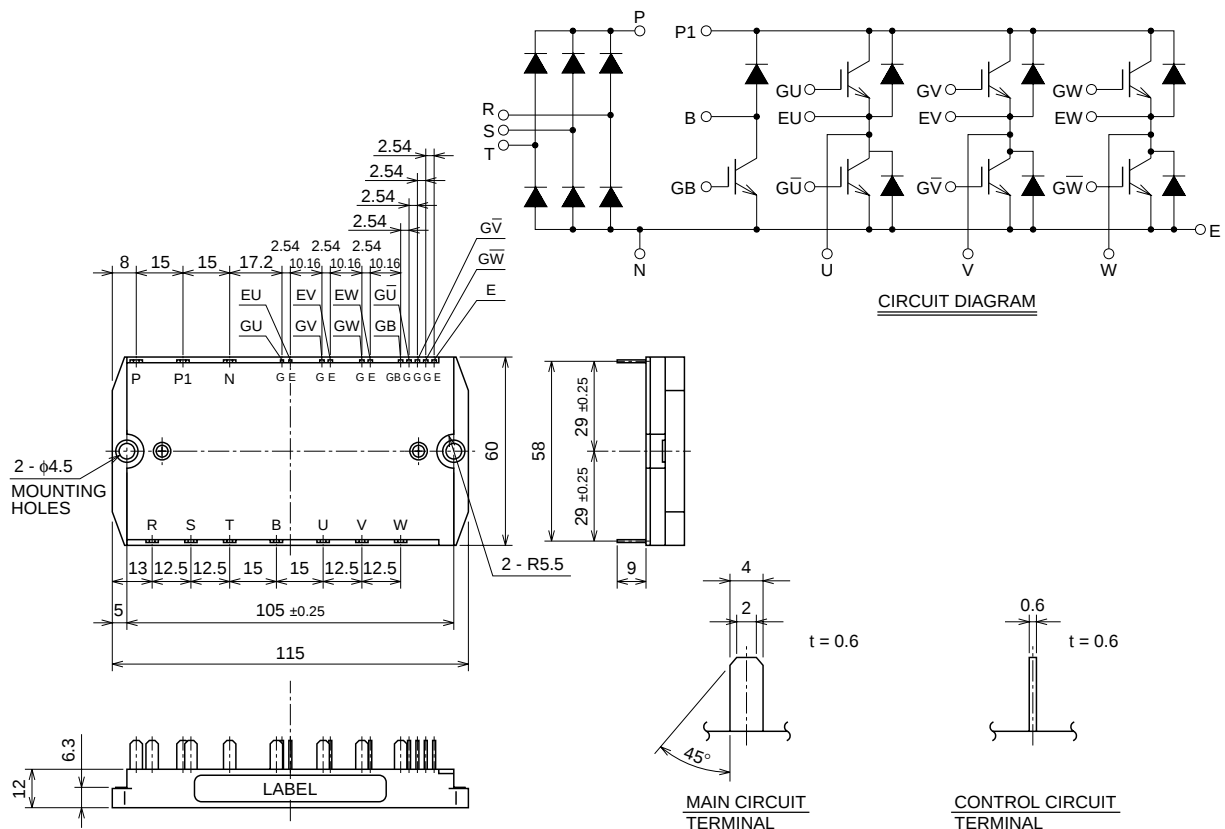
Yellow Card No. E80276 (N)
File No. E80271

APPLICATION

AC & DC motor controls, General purpose inverters, Servo controls, NC, Robotics

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



CM50MD-12H

MEDIUM POWER SWITCHING USE
INSULATED TYPE

MAXIMUM RATINGS (T_j = 25°C) INVERTER PART

Symbol	Parameter	Condition	Rating	Unit
V _{CES}	Collector-emitter voltage	G – E Short	600	V
V _{GES}	Gate-emitter voltage	C – E Short	±20	V
I _C	Collector Current	T _c = 25°C	50	A
I _{CM}		PULSE (Note. 2)	100	A
I _E (Note. 1)	Emitter Current	T _c = 25°C	50	A
I _{EM} (Note. 1)		PULSE (Note. 2)	100	A
P _C (Note. 3)	Maximum collector dissipation	T _f = 25°C	104	W

BRAKE PART

Symbol	Parameter	Condition	Rating	Unit
V _{CES}	Collector-emitter voltage	G – E Short	600	V
V _{GES}	Gate-emitter voltage	C – E Short	±20	V
I _C	Collector Current	T _c = 25°C	50	A
I _{CM}		PULSE (Note. 2)	100	A
P _C (Note. 3)	Maximum Collector dissipation	T _f = 25°C	104	W
V _{RRM}	Repetitive peak reverse voltage	Clamp diode part	600	V
I _{FM} (Note. 3)	Forward current	Clamp diode part	50	A

CONVERTER PART

Symbol	Parameter	Condition	Rating	Unit
V _{RRM}	Repetitive peak reverse voltage		800	V
E _a	Recommended AC input voltage		220	V
I _O	DC output current	3φ rectifying circuit	50	A
I _{FSM}	Surge (non-repetitive) forward current	1 cycle at 60Hz, peak value Non-repetitive	500	A
I ² t	I ² t for fusing	Value for one cycle of surge current	1.0X10 ³	A ² s

COMMON RATING

Symbol	Parameter	Condition	Rating	Unit
T _j	Junction temperature		–40 ~ +150	°C
T _{stg}	Storage temperature		–40 ~ +125	°C
V _{iso}	Isolation voltage	AC 1 min.	2500	V
—	Mounting torque	Mounting M4 screw	0.98 ~1.47	N·m
—	Weight	Typical value	100	g

CM50MD-12H

MEDIUM POWER SWITCHING USE
INSULATED TYPEELECTRICAL CHARACTERISTICS ($T_j = 25^\circ\text{C}$)
INVERTER PART

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
ICES	Collector cutoff current	$V_{CE} = V_{CES}, V_{GE} = 0V$	—	—	1	mA
$V_{GE(th)}$	Gate-emitter threshold voltage	$I_C = 5.0\text{mA}, V_{CE} = 10V$	4.5	6	7.5	V
IGES	Gate-emitter cutoff current	$V_{GE} = V_{GES}, V_{CE} = 0V$	—	—	0.5	μA
$V_{CE(sat)}$	Collector-emitter saturation voltage	$T_j = 25^\circ\text{C}$	—	2.2	2.8	V
		$T_j = 150^\circ\text{C}$	—	—	—	
Cies	Input capacitance	$V_{CE} = 10V$ $V_{GE} = 0V$	—	—	5.0	nF
Coēs	Output capacitance		—	—	3.8	nF
Cres	Reverse transfer capacitance		—	—	1.0	nF
QG	Total gate charge	$V_{CC} = 300V, I_C = 50A, V_{GE} = 15V$	—	150	—	nC
$t_d(\text{on})$	Turn-on delay time	$V_{CC} = 300V, I_C = 50A$	—	—	120	ns
t_r	Turn-on rise time	$V_{GE1} = V_{GE2} = 15V$	—	—	300	ns
$t_d(\text{off})$	Turn-off delay time	$R_G = 13\Omega$	—	—	200	ns
t_f	Turn-off fall time	Resistive load	—	—	300	ns
V_{EC} (Note. 1)	Emitter-collector voltage	$I_E = 50A, V_{GE} = 0V$	—	—	2.8	V
t_{rr} (Note. 1)	Reverse recovery time	$I_E = 50A, V_{GE} = 0V$	—	—	110	ns
Q_{rr} (Note. 1)	Reverse recovery charge	$di_e / dt = -100A / \mu\text{s}$	—	0.14	—	μC
$R_{th(j-f)Q}$ (Note. 5)	Thermal resistance	IGBT part, Per 1/6 module	—	—	1.2	$^\circ\text{C/W}$
$R_{th(j-f)R}$ (Note. 5)		FWDi part, Per 1/6 module	—	—	1.9	$^\circ\text{C/W}$

BRAKE PART

Symbol	Parameter	Condition	Limits			Unit
			Min.	Typ.	Max.	
ICES	Collector cutoff current	$V_{CE} = V_{CES}, V_{GE} = 0V$	—	—	1	mA
$V_{GE(th)}$	Gate-emitter threshold voltage	$I_C = 5.0\text{mA}, V_{CE} = 10V$	4.5	6	7.5	V
IGES	Gate-emitter cutoff current	$V_{GE} = V_{GES}, V_{CE} = 0V$	—	—	0.5	μA
$V_{CE(sat)}$	Collector-to-emitter saturation voltage	$T_j = 25^\circ\text{C}$	—	2.2	2.8	V
		$T_j = 150^\circ\text{C}$	—	—	—	
Cies	Input capacitance	$V_{CE} = 10V$ $V_{GE} = 0V$	—	—	5.0	nF
Coēs	Output capacitance		—	—	3.8	nF
Cres	Reverse transfer capacitance		—	—	1.0	nF
QG	Total gate charge	$V_{CC} = 300V, I_C = 50A, V_{GE} = 15V$	—	150	—	nC
V_{FM}	Forward voltage drop	$I_F = 50A$, Clamp diode part	—	—	1.5	V
$R_{th(j-f)Q}$ (Note. 5)	Thermal resistance	IGBT part	—	—	1.2	$^\circ\text{C/W}$
$R_{th(j-f)R}$ (Note. 5)		Clamp diode part	—	—	1.7	$^\circ\text{C/W}$

CONVERTER PART

Symbol	Parameter	Condition	Limits			Unit
			Min.	Typ.	Max.	
IRRM	Repetitive reverse current	$V_R = V_{RRM}, T_j = 150^\circ\text{C}$	—	—	8	mA
V_{FM}	Forward voltage drop	$I_F = 50A$	—	—	1.5	V
$R_{th(j-f)}$ (Note. 5)	Thermal resistance	Per 1/6 module	—	—	1.7	$^\circ\text{C/W}$

Note 1. I_E , V_{EC} , t_{rr} , Q_{rr} & di_e/dt represent characteristics of the anti-parallel, emitter to collector free-wheel diode.2. Pulse width and repetition rate should be such that the device junction temp. (T_j) does not exceed T_{jmax} rating.3. Junction temperature (T_j) should not increase beyond 150°C .

4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

5. Thermal resistance is specified under following conditions.

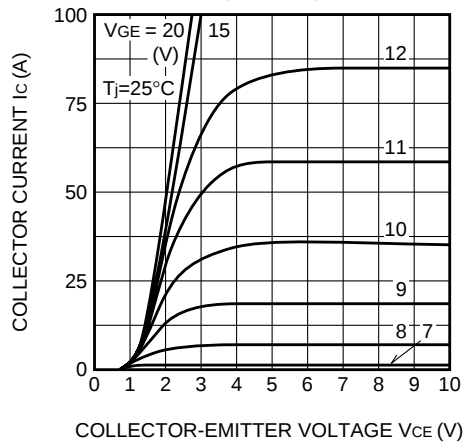
- The conductive grease applied, between module and fin.
- Al plate is used as fin.

CM50MD-12H

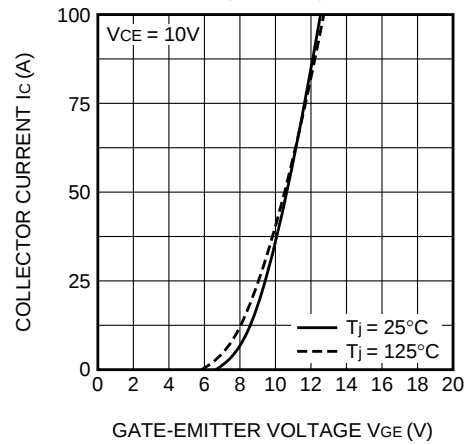
MEDIUM POWER SWITCHING USE
INSULATED TYPE

PERFORMANCE CURVES

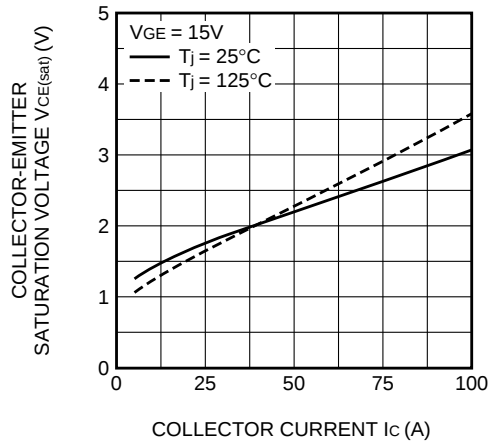
OUTPUT CHARACTERISTICS
(TYPICAL)



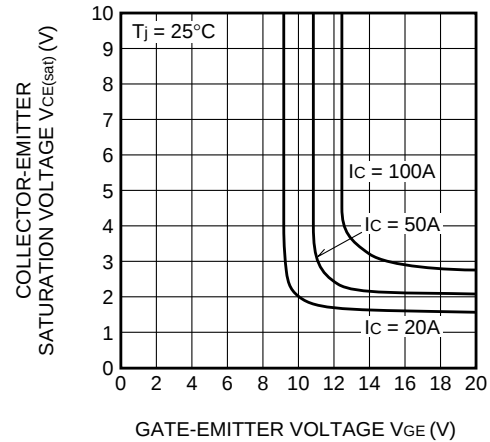
TRANSFER CHARACTERISTICS
(TYPICAL)



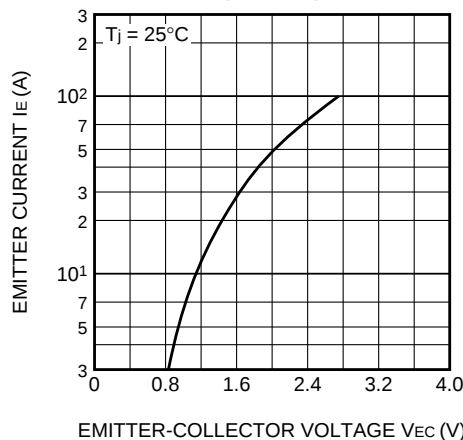
COLLECTOR-EMITTER SATURATION
VOLTAGE CHARACTERISTICS
(TYPICAL)



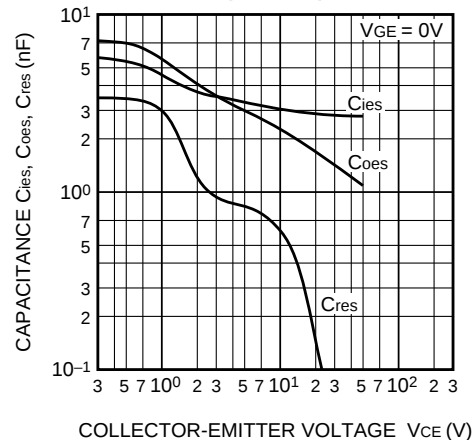
COLLECTOR-EMITTER SATURATION
VOLTAGE CHARACTERISTICS
(TYPICAL)



FREE-WHEEL DIODE
FORWARD CHARACTERISTICS
(TYPICAL)



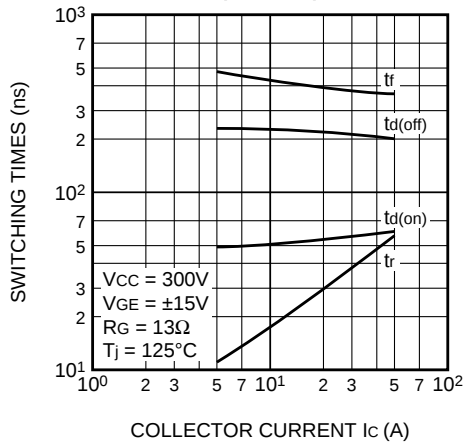
CAPACITANCE VS. V_{ce}
(TYPICAL)



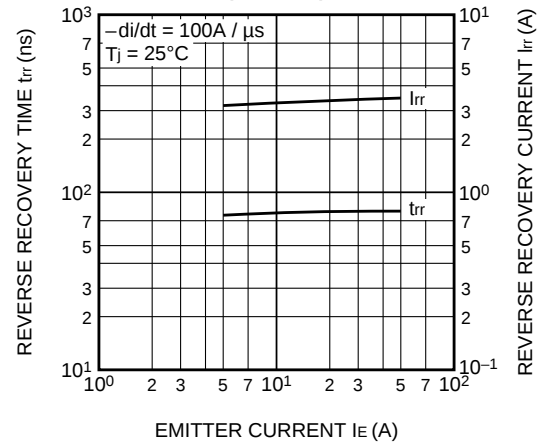
CM50MD-12H

MEDIUM POWER SWITCHING USE
INSULATED TYPE

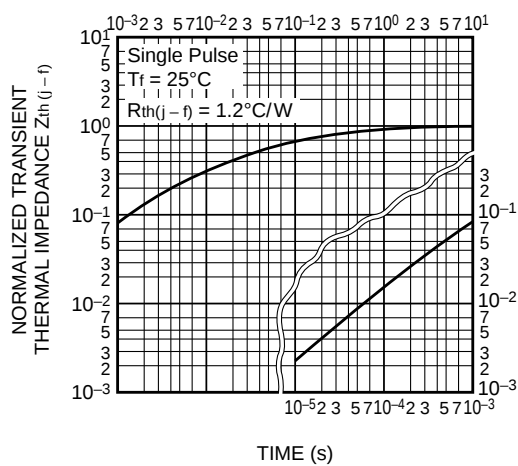
HALF-BRIDGE
SWITCHING CHARACTERISTICS
(TYPICAL)



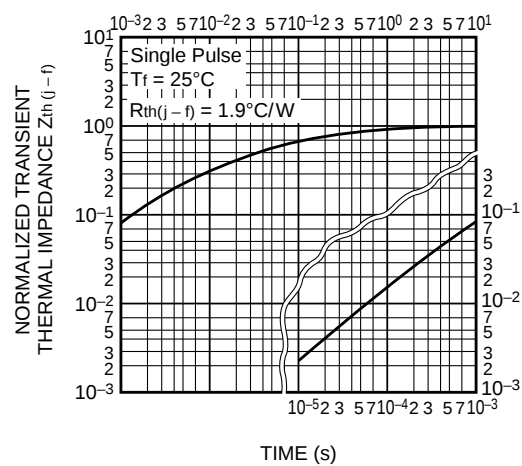
REVERSE RECOVERY CHARACTERISTICS
OF FREE-WHEEL DIODE
(TYPICAL)



TRANSIENT THERMAL
IMPEDANCE CHARACTERISTICS
(IGBT part)



TRANSIENT THERMAL
IMPEDANCE CHARACTERISTICS
(FWDi part)



V_{GE} - GATE CHARGE
(TYPICAL)

